Response to Office Action of December 19, 2006

**LISTING OF CLAIMS** 

This listing of claims will replace all prior versions, and listings, of claims in the

application.

1. (Canceled)

2. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 1, wherein a shape of the grains of polycrystalline silicon is

anisotropic, and the grain boundaries are primary grain boundaries.

3. (Previously Presented) The flat panel display device with polycrystalline silicon thin

film transistors according to claim 4, wherein a shape of the grains of polycrystalline silicon is

anisotropic, and the grain boundaries include side grain boundaries of anisotropic grains.

4. (Previously Presented) A flat panel display device with polycrystalline silicon thin film

transistors, comprising:

a pixel portion divided by gate lines and data lines and comprising thin film transistors

driven by signals applied by the gate lines and data lines; and

a driving circuit portion comprising thin film transistors connected to the gate lines and

data lines respectively to apply signals to the pixel portion,

wherein an average number of grain boundaries of polycrystalline silicon formed in an

active channel region of each thin film transistor installed at the driving circuit portion and meet

a current direction line is at least one or more less than an average number of grain boundaries

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of polycrystalline silicon formed in an active channel region of each thin film transistor installed at the pixel portion and meet a current direction line for a unit area of active channels,

wherein the polycrystalline silicon grain boundaries formed in the active channel region of each thin film transistor installed at the driving circuit portion include primary polycrystalline silicon grain boundaries that are inclined to the current direction line at an angle of about – 45 to 45°,

wherein the polycrystalline silicon grain boundaries formed in the active channel region of each thin film transistor installed at the pixel portion include primary polycrystalline silicon grain boundaries that are inclined to the current direction line at an angle of about – 45 to 45°, and

wherein the active channel of each thin film transistor installed at the pixel portion is longer than the active channel of each thin film transistor installed at the driving circuit portion.

5. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 1, wherein:

the polycrystalline silicon grain boundaries formed in active channel regions of the one or more thin film transistors installed at the driving circuit portion are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of 45 to 135°; and

the polycrystalline silicon grain boundaries formed in active channel regions of the thin film transistor installed at the pixel portion are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of – 45 to 45°.

6. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 1, wherein:

the polycrystalline silicon grain boundaries formed in active channel regions of the one or more thin film transistors installed at the driving circuit portion are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of

 $-45 \text{ to } 45^{\circ};$ 

the polycrystalline silicon grain boundaries formed in active channel regions of the thin film transistor installed at the pixel portion are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of – 45 to 45°; and

the length of the active channels of the thin film transistor installed at the pixel portion is the same as length of the active channels of the thin film transistor installed at the driving circuit portion.

- 7. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 2, wherein the polycrystalline silicon is fabricated by a sequential lateral solidification method.
- 8. (Previously Presented) The flat panel display device with polycrystalline silicon thin film transistors according to claim 3, wherein the polycrystalline silicon is fabricated by a metal induced lateral crystallization method.
- 9. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 1, wherein shape of the grains of polycrystalline silicon is isotropic.
- 10. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 7, wherein a length of the active channels of the thin film transistor

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installed at the pixel portion is the same as length of the active channels of the one or more thin

film transistors installed at the driving circuit portion.

11. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 7, wherein the polycrystalline silicon is formed by eximer laser

annealing.

12. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 1, wherein the average grain size of polycrystalline silicon grains

included in active channel region of a gate in the driving circuit portion is larger than that of

polycrystalline silicon grains included in active channel region of a gate in the pixel portion.

13. (Previously Presented) The flat panel display device with polycrystalline silicon thin

film transistors according to claim 4, wherein the flat panel display device is one of an organic

electroluminescent device and a liquid crystal display device.

14. (Withdrawn) A flat panel display device with polycrystalline silicon thin film transistor

comprising:

a switching thin film transistor for transmitting data signals; and

a driving thin film transistor for driving the organic electroluminescent device so that a

certain amount of current flows through organic electroluminescent device according to the data

signals, wherein the average number of grain boundaries of polycrystalline silicon which are

formed in active channel regions of the driving thin film transistor and meet a current direction

line is at least one or more greater than the average number of grain boundaries of

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polycrystalline silicon which are formed in active channel regions of the switching thin film

transistor and meet a current direction line for a unit area of active channels.

15. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein a shape of the grains of polycrystalline silicon is

anisotropic, and the grain boundaries are primary grain boundaries.

16. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein a shape of the grains of polycrystalline silicon is

anisotropic, and the grain boundaries are side grain boundaries of anisotropic grains.

17. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein:

the polycrystalline silicon grain boundaries formed in active channel regions of the

switching thin film transistor are arranged in such a way that the polycrystalline silicon grain

boundaries are inclined to the current direction line at an angle of – 45 to 45°;

the polycrystalline silicon grain boundaries formed in active channel regions of the

driving thin film transistor are arranged in such a way that the polycrystalline silicon grain

boundaries are inclined to the current direction line at an angle of -45 to 45°; and

the length of the active channels of the driving thin film transistor is longer than length of

the active channels of the switching thin film transistor.

18. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein:

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the polycrystalline silicon grain boundaries formed in active channel regions of the switching thin film transistor are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of 45 to 135°; and

the polycrystalline silicon grain boundaries formed in active channel regions of the driving thin film transistor are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of – 45 to 45°.

19. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 14, wherein:

the polycrystalline silicon grain boundaries formed in active channel regions of the switching thin film transistor are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of – 45 to 45°;

the polycrystalline silicon grain boundaries formed in active channel regions of the driving thin film transistor are arranged in such a way that the polycrystalline silicon grain boundaries are inclined to the current direction line at an angle of – 45 to 45°; and

the length of the active channels of the driving thin film transistor is the same as length of the active channels of the switching thin film transistor.

- 20. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 15, wherein the polycrystalline silicon is fabricated by a sequential lateral solidification method.
- 21. (Withdrawn) The flat panel display device with polycrystalline silicon thin film transistor according to claim 16, wherein the polycrystalline silicon is fabricated by a metal induced lateral crystallization method.

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22. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein shape of the grains of polycrystalline silicon is

isotropic.

23. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 22, wherein a length of the active channels of the driving thin film

transistor is the same as length of the active channels of the switching thin film transistor.

24. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 22, wherein the polycrystalline silicon is formed by eximer laser

annealing.

25. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein the average grain size of polycrystalline silicon grains

included in active channel region of a gate in the switching thin film transistor is larger than that

of polycrystalline silicon grains included in active channel region of a gate in the driving thin film

transistor.

26. (Withdrawn) The flat panel display device with polycrystalline silicon thin film

transistor according to claim 14, wherein the flat panel display device is one of an organic

electroluminscent device and a liquid crystal display device.

27. (Withdrawn) A CMOS thin film transistor characterized in that a P type thin film

transistor and an N type thin film transistor have a different number of primary grain boundaries

of polycrystalline silicon included in active channel regions, and the number of grain boundaries

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included in the P type thin film transistor is at least one or more less than the number of grain boundaries included in the N type thin film transistor.

- 28. (Withdrawn) The CMOS thin film transistor according to claim 27, wherein channel length of the P type thin film transistor is the same as that of the N type thin film transistor.
- 29. (Withdrawn) The CMOS thin film transistor according to claim 27, wherein the primary grain boundaries of polycrystalline silicon included in the active channel regions of the N type thin film transistor and P type thin film transistor are perpendicular to a current flow direction.
- 30. (Withdrawn) The CMOS thin film transistor according to claim 27, wherein the polycrystalline silicon is fabricated by a sequential lateral solidification crystallization method.
- 31. (Withdrawn) The CMOS thin film transistor according to claim 27, wherein the primary grain boundaries are not included in the P type thin film transistor.
- 32. (Withdrawn) The CMOS thin film transistor according to claim 27, wherein the number of primary grain boundaries included in the P type thin film transistor is 2 or less.
- 33. (Withdrawn) The CMOS thin film transistor according to claim 32, wherein the number of primary grain boundaries included in the N type thin film transistor is 6, and the number of primary grain boundaries included in the P type thin film transistor is 2.

- 34. (Withdrawn) The CMOS thin film transistor according to claim 27, wherein the CMOS thin film transistor includes one of an LDD structure an off-set structure.
  - 35. (Withdrawn) A display device using the CMOS thin film transistor of claim 27.
- 36. (Withdrawn) The display device according to claim 35, wherein the display device is one of a liquid crystal display device and an organic electroluminescent display device.
- 37. (Withdrawn) A flat panel display device comprising green, red and blue pixel regions, and driving thin film transistor for driving each of the pixels having the same length and width of active channels, wherein the number of grain boundaries of polycrystalline silicon included in active channel regions of the driving thin film transistor is different from each other for each pixel.
- 38. (Withdrawn) The flat panel display device according to claim 37, wherein the green pixel region has the largest number of the primary grain boundaries of polycrystalline silicon, and the red pixel region and the blue pixel region have the same number of the primary grain boundaries of polycrystalline silicon.
- 39. (Withdrawn) The flat panel display device according to claim 37, wherein the number of the primary grain boundaries of polycrystalline silicon is increased in the order of green, blue and red pixel regions.
- 40. (Withdrawn) The flat panel display device according to claim 37, wherein the green pixel region and the blue pixel region have the same number of the primary grain boundaries of

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polycrystalline silicon, and the red pixel region has the smallest number of the primary grain

boundaries of polycrystalline silicon.

41. (Withdrawn) The flat panel display device according to claim 37, wherein the grain

boundaries are perpendicular to current flowing direction in active channel regions of each

driving thin film transistor.

42. (Withdrawn) The flat panel display device according to claim 41, wherein the grain

boundaries are primary grain boundaries.

43. (Withdrawn) The flat panel display device according to claim 41, wherein the grain

boundaries are side grain boundaries of anisotropic grains.

44. (Withdrawn) The flat panel display device according to claim 43, wherein the flat

panel display device has the smallest number of primary grain boundaries included in active

channel regions of driving thin film transistor of the green pixel region.

45. (Withdrawn) The flat panel display device according to claim 44, wherein the

number of primary grain boundaries included in active channel regions of driving thin film

transistor of the blue pixel region is the same as or less than the number of primary grain

boundaries included in active channel regions of driving thin film transistor of the red pixel

region.

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46. (Withdrawn) The flat panel display device according to claim 37, wherein the flat

panel display device is one of a liquid crystal display device, an inorganic electroluminescent

device and an organic electroluminescent device.

47. (Previously Presented) A flat panel display device with polycrystalline silicon thin

film transistors, comprising:

switching thin film transistors for transmitting data signals; and

driving thin film transistors for driving an organic electroluminescent device so that a

certain amount of current flows through the organic electroluminescent device according to the

data signals,

wherein an average number of grain boundaries of polycrystalline silicon which are

formed in an active channel region of each driving thin film transistor and meet a current

direction line is more than zero and at least one or more less than an average number of grain

boundaries of polycrystalline silicon which are formed in an active channel region of each

switching thin film transistor and meet a current direction line for a unit area of an active

channel.

48. (Canceled)

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